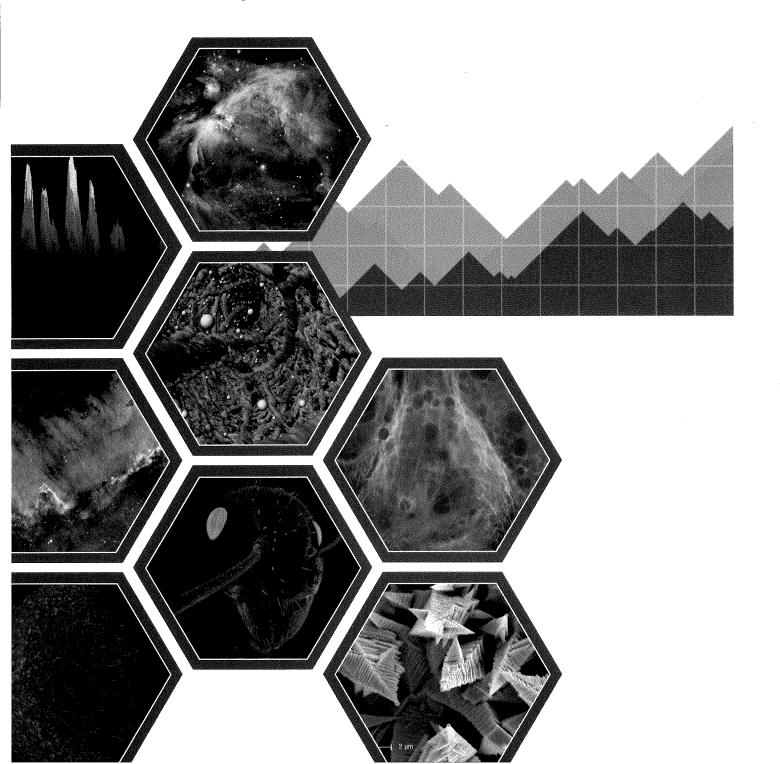


System Performance Booklet





Returns Report

Customer

UHAWAII

Returns No

R68049

Classification

WARRANTY

Customer RMA No

None

Equipment Details

Model

Serial Number

Head

DW936N-BEX2-DD-99BR

CCD-25847

Card

ASE-01188

PSU

PS-40 s/n CCD-25847

PS-29

Multi 10

ACC-ASE-01957

Other

Mains cable

Reported Fault

Camera shutter doesn't seem to be working, the camera doesn't return an image and shows the sensor temperature as -105 when we set the temperature to -60°C.

Diagnosis

Unable to confirm customer reported fault. No fault found with camera.

Work Carried Out

Full system QC & new performance sheets completed: - Passed.

Receipt Date Work Complete P

Passed For Shipping Si

Shipped

Date

30/09/2021

09/11/2021

09/11/2021

Initials

PMC

RL

PGF



System Overview

Description	M	odel		Serial Number							
CCD Head	D	W	9	36N - BEX2-DD-99BR CCD-258			D-25847				
TE-Cooler performance (٧)				High Ultra-high				~		
Power Supply Units			PS -29			PS -40					
					·				~		
Accessories		LM-	-			MFL-		٠.			
Serial/Batch Number											
Other									THE COLUMN TO TH		

 ∇ Sensor types are defined in Table 1 using the last two letters in box Model Number.

CCD Details

Manufacturer / Model No.		Pixels	Serial Number
E2V	CCD42-40	2048x2048, 13.5μm x 13.5μm	19471-66-03
	Mary .		

Special Features	(*)		(*)
NIMO	~	Custom shutter	~
Fringe Suppression		Custom Cables	
Shielded Anti-Blooming			

Window Variant	(*)		(~)
VUV-UV Parallel		NUV-Enhanced Parallel	
Broadband VUV-NIR Wedged		Broadband VUV-NIR Parallel	,
Broadband VIS-NIR Wedged		Broadband VIS-NIR Parallel	
VIS-NIR Enhanced Wedged		Bose-Einstein 780nm Wedged	
None		Other	

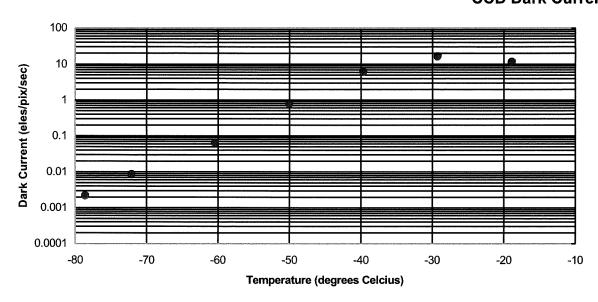


Summary of System Test Data

Readout Noise ◆1 and Base Mean Level ◆2

		CCD Sen	sitivity ≠ 3	Single Pi	xel Noise	Base Me	an Level
A/D Rate	A/D Rate Preamp MHz - all 16 bit setting		/D count	electro	ns rms	A/D counts	
MHz - all 16 bit			High Capacity Mode	High Sensitivity Mode	High Capacity Mode	High Sensitivity Mode	High Capacity Mode
5.0	x1	6.9	22.3	41.2	111.5	`2723	1175
5.0	x2	3.7	12.0	34.7	80.9	4366	1383
5.0	x4	1.8	6.5	28.1	65.2	5801	1308
3.0	x1	4.4	16.4	21.2	81.0	1008	784
3.0	x2	2.3	9.0	14.4	50.7	1846	1387
3.0	x4	1.1	4.6	11.6	40.6	2727	2523
1.0	x1	4.0	17.2	10.3	40.4	768	1048
1.0	x2	2.2	8.5	8.2	27.4	1189	1705
1.0	x4	1.1	4.7	6.9	24.6	1932	2916
0.05	x1	4.3	18.0	5.0	17.8	805	1069
0.05	x2	2.2	9.3	4.1	13.1	1234	1726
0.05	x4	1.1	4.8	3.6	11.3	2026	2946
Saturatio	n Signal peı	pixel <i>◆14</i>		12824	5	electrons	

CCD Dark Current



Minimum Dark Current Achievable ◆4	0.002087	electrons/pixel/sec		ec
@ Sensor Temperature of ◆5	-77.3	°C	16.0	°C cooling water
CCD Dark Current Uniformity better than ▶6	0.724128	electrons/pixel/sec		ес



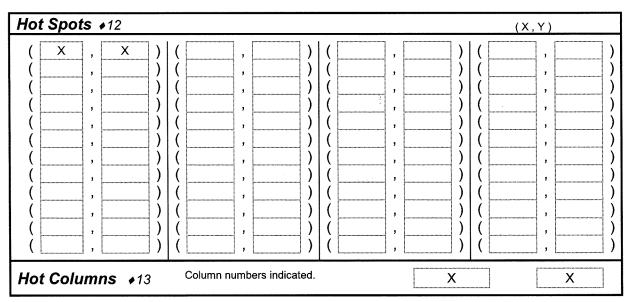
Linearity and Uniformity

Linearity better than ≠7	1	% over 16 bits
Response Uniformity better than ◆8	1.96	%

Response Defects

White/Black Spots +9				(X, Y) Number of Pixels
X,Y	Number of Pixels	X ,	Υ .	Number of Pixels
White/Black Columns Column numbers indicated.	◆10		X	X
Traps •11	Column numbers indicated.		Χ	X

Dark Current Defects





Test Conditions

Readout Noise tested at	-90	°C with	16	°C water
Base Mean Level measured at	-90	°C with	16	°C water
Dark Current Uniformity tested at	-50	°C with	16	°C-water
Blemishes tested at	-50	°C with	16	°C water

Custom Testing

Signed

System Passed for Shipping

Date

RAYMOND CLARKE

1ST NOVEMBER 2021

HEADBOARD FPGA
Hardware Version #

SOLIS
SDK
Shipping Software Version #

SOLIS
SDK
Testing Software Version #

4.32.30061.0

SPGA
20.12

SDK
20.12

SDK
2.104.33061.0

abla Table 1; Key code to define the meanings of the last two letters in the Model Number

Sensor Options						
OE	Open electrode	BV	BI + VIS (550nm) optimised)			
FI	Front illuminated (FI)	BR	BI + NIR (850) optimised			
UV	FI+UV coating	BR-DD	BI + NIR +deepdepletion			
FO	FI + Fibre optic	BN	BI with no AR coating			
FI-DD	FI + deep depletion	FK	Fast Kinetics (masked; 3011 only)			
BU2	Back Illuminated (BI) + 250nm UV optimised	KT	Kodak FI coating			
BU	BI + UV (350nm) optimised					



Performance Notes

- Readout Noise is measured for both single pixel (SP) and fully vertically binned (FVB) with the CCD in darkness at temperature indicated and minimum exposure time. Noise values will change with preamplifier gain selection [PAG].
- ♦2 Average electronic DC offset for CCD in darkness at temperature indicated and minimum exposure time under dark conditions measured by single pixel (SP) for imaging systems and by (FVB) for spectroscopic systems.
- Sensitivity is calculated in photoelectrons per A/D count from measurements of the Photon Transfer Curves.
- Dark current falls exponentially with temperature. However, for a given temperature the actual dark current can vary by more than an order of magnitude from device to device. The devices are specified in terms of minimum dark current achievable rather than minimum temperature.
- ◆5 Minimum temperature achieved for thermoelectric (TE) cooler set to maximum value with water cooling
- RMS (root mean square) deviation of dark current for fully binned operation for spectroscopic cameras, or full resolution image for imaging cameras, under dark conditions at temperature indicated (pixel/column defects not included). This variation is mainly cosmetic since it is fully subtractable without significant loss of performance.
- √7 Linearity is measured from a plot of Counts vs. Signal over the 16 bit dynamic range. Linearity is expressed as a %age deviation from a straight line fit. This quantity is not measured on individual systems.
- RMS (root mean square) deviation from the average response of the CCD in fully binned operation for spectroscopic cameras, or full resolution image for imaging cameras, illuminated with uniform white light (defects not included).
- ♦9 White/black spots have signals >25% above/below the average (i.e >25% contrast) with uniform illumination across the sensor.
- ◆10 Columns whose signals have >10% contrast in binned operation with uniform illumination across the sensor for spectroscopic cameras, ≥ 10 black spots per column for imaging cameras.
- ◆11 Pixels which absorb charge as it is clocked through the defective area. When the light source is switched off, the signal from the trap appears to drop off more slowly than the signal from the surrounding pixels.
- ♦12 A spot can be up to 3 pixels in size. For Grade A devices, hot spots are counted if they exhibit >50 times the maximum specified dark current at the test temperature indicated.
- ♠13 A column is considered defective if >10 pixels are affected, or if the column exhibits >2 times the maximum specified dark current at the test temperature indicated.
- ◆14 Saturation Signal per pixel is measured at 1MHz PreAmp x1 High Sensitivity mode